



Product Summary

BV _{DSS}	R _{DS(ON)} max	Ι _D T _A = +25°C
2014	30mΩ @ V _{GS} = 10V	6A
30V	$42m\Omega @ V_{GS} = 4.5V$	5A

Description

This new generation MOSFET has been designed to minimize the onstate resistance (R_{DS(ON)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- **DC-DC Converters**
- **Power Management Functions**
- Backlighting

30V N-CHANNEL ENHANCEMENT MODE MOSFET

Features and Benefits

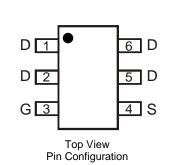
- Low Input Capacitance
- Low On-Resistance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

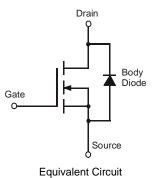
Mechanical Data

- Case: TSOT26 •
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Tin Finish Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.013 grams (Approximate)



Top View





Ordering Information (Note 4)

	Part Number	Case	Packaging				
	DMG6402LVT-7	TSOT26	3,000/Tape & Reel				
	DMG6402LVT-13	TSOT26	10,000/Tape & Reel				
Notes:	Notes: 1 No purposely added lead Fully FU Directive 2002/95/FC (RoHS) 2011/65/FU (RoHS 2) & 2015/863/FU (RoHS 3) compliant						

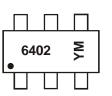
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



6402 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: G = 2019) M = Month (ex: 9 = September)

Date Code Kev

Year	201	1	~		2019	20	20	2021		2022	2	2023
Code	Y		~		G	ŀ	-			J		К
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V _{DSS}	30	V		
Gate-Source Voltage			V _{GSS}	±20	V
S		$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	6.0 4.8	A
Continuous Drain Current (Note 5) V_{GS} = 10V	t < 10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	7.5 5.9	A
	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	5.0 4.0	A
Continuous Drain Current (Note 5) $V_{GS} = 4.5V$	t < 10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	6 4.8	A
Maximum Body Diode Forward Current (Note 5)	ls	2	A		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%	I _{DM}	31	А		

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Total Power Dissipation (Note 5)	T _A = +25°C	D	1.75	W	
Total Power Dissipation (Note 5)	T _A = +70°C	PD	1.1	vv	
Thermal Desistance, Junction to Ambient (Note 5)	Steady State	D	72	°C/W	
Thermal Resistance, Junction to Ambient (Note 5)	t < 10s	$R_{ extsf{ heta}}JA$	50		
Thermal Resistance, Junction to Case (Note 5)	$R_{\theta JC}$	23			
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C	

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

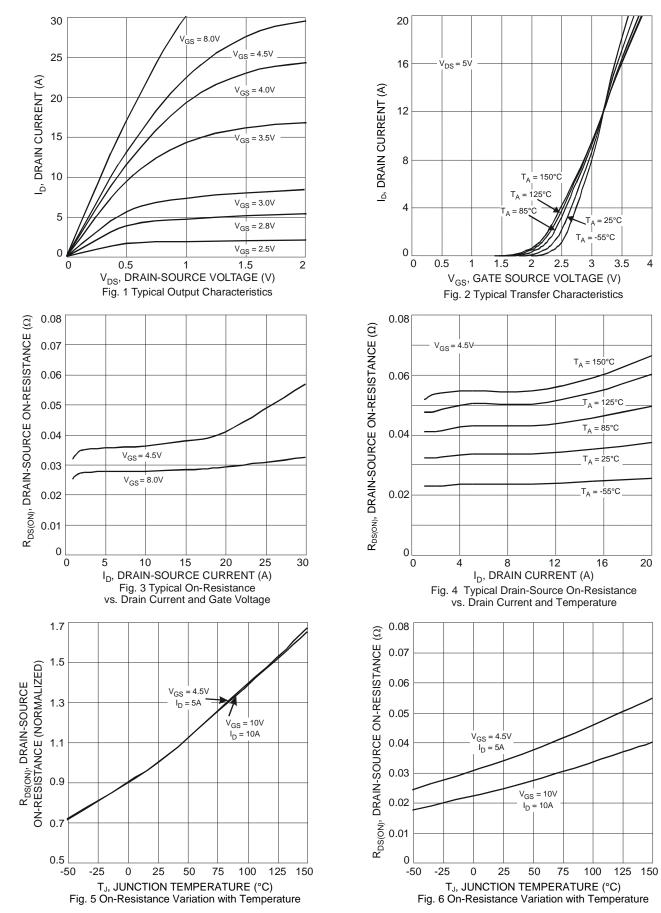
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 6)	eyinse.		.,,,,	max	Unit		
Drain-Source Breakdown Voltage	BV _{DSS}	30	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current	IDSS			1	μA	$V_{DS} = 30V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}			±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 6)							
Gate Threshold Voltage	V _{GS(TH)}	1	1.5	2	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	
Static Drain-Source On-Resistance		_	22	30	mΩ	$V_{GS} = 10V, I_D = 7A$	
Static Dian-Source On-Resistance	R _{DS(ON)}	_	32	42	11152	V _{GS} = 4.5V, I _D = 5.6A	
Forward Transfer Admittance	Y _{fs}		10	_	S	$V_{DS} = 5V, I_D = 7A$	
Diode Forward Voltage	V _{SD}	_	0.75	1.0	V	$V_{GS} = 0V, I_S = 1A$	
DYNAMIC CHARACTERISTICS (Note 7)						·	
Input Capacitance	Ciss		498	_			
Output Capacitance	Coss	_	52	_	pF	V _{DS} = 15V, V _{GS} = 0V f = 1.0MHz	
Reverse Transfer Capacitance	C _{rss}		45	_			
Gate Resistance	R _G	_	2.4	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
Total Gate Charge	Qg	_	11.4	_			
Gate-Source Charge	Q _{gs}	_	1.4	_	nC	V _{GS} = 10V, V _{DS} = 15V, I _D = 5.8A	
Gate-Drain Charge	Q _{gd}	_	2	_			
Turn-On Delay Time	t _{D(ON)}		3.4				
Turn-On Rise Time	t _R		6.2	_	ns	$V_{DD} = 15V, V_{GS} = 10V,$	
Turn-Off Delay Time	t _{D(OFF)}		13.9	_	115	$R_L = 2.6\Omega, R_G = 3\Omega$	
Turn-Off Fall Time	tF		2.8	_	1		

Device mounted on FR-4 substrate PC board, 2oz copper, with thermal vias to bottom layer 1inch square copper plate.
Short duration pulse test used to minimize self-heating effect.

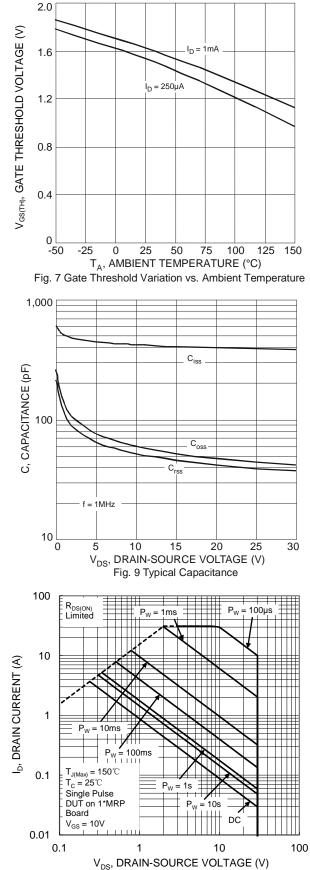
7. Guaranteed by design. Not subject to production testing.

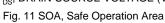
Notes:

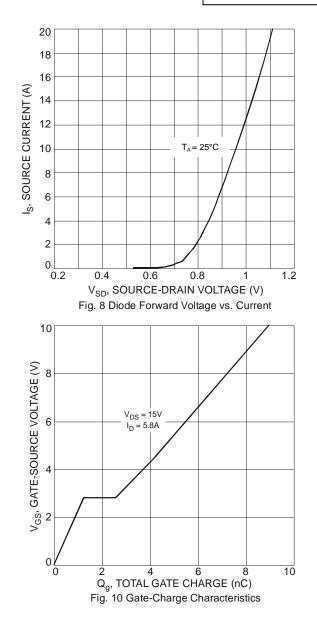








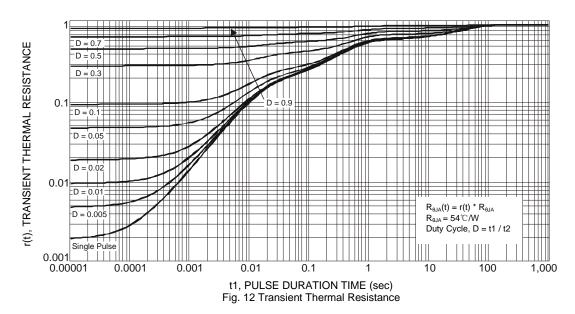




NEW PRODUCT

DMG6402LVT Document number: DS35831 Rev. 5 - 2



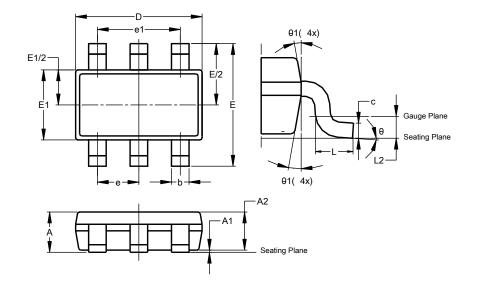




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

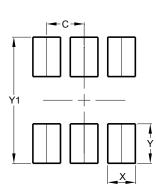
TSOT26



TSOT26							
Dim	Min	Max	Тур				
Α	-	1.00	-				
A1	0.010	0.100	-				
A2	0.840	0.900	-				
D	2.800	3.000	2.900				
Е	2.800 BSC						
E1	1.500	1.700	1.600				
b	0.300	0.450	-				
С	0.120	0.200	-				
е	0.950 BSC						
e1	1	.900 BS	С				
L	0.30	-					
L2	0.250 BSC						
θ	0°	8°	4°				
θ1	4°	12°	-				
Α	II Dimen	sions in	mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



TSOT26

Dimensions	Value (in mm)
С	0.950
Х	0.700
Y	1.000
Y1	3.199



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